



TSM3400

30V N-Channel Enhancement Mode MOSFET

SOT-23



Pin assignment:

1. Gate
2. Source
3. Drain

$$V_{DS} = 30V$$

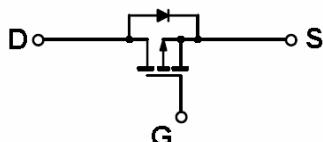
$$R_{DS(on)}, V_{GS} @ 4.5V, I_{DS} @ 2A = 70m\Omega$$

$$R_{DS(on)}, V_{GS} @ 10V, I_{DS} @ 3.5A = 50m\Omega$$

Features

- ◊ Rugged and reliable
- ◊ High density cell design for ultra low on-resistance
- ◊ Excellent thermal and electrical capabilities
- ◊ Compact and low profile SOT-23 package

Block Diagram



Ordering Information

| Part No. | Packing | Package |
|-----------|-------------|---------|
| TSM3400CX | Tape & Reel | SOT-23 |

Absolute Maximum Rating ($T_a = 25^\circ C$ unless otherwise noted)

| Parameter | Symbol | Limit | Unit |
|--|--------------------|-------------|------------|
| Drain-Source Voltage | V_{DS} | 30V | V |
| Gate-Source Voltage | V_{GS} | ± 20 | V |
| Continuous Drain Current | I_D | 3.5 | A |
| Pulsed Drain Current | I_{DM} | 13 | A |
| Maximum Power Dissipation | $T_a = 25^\circ C$ | 1.25 | W |
| | $T_a = 75^\circ C$ | 0.8 | |
| Operating Junction Temperature | T_J | +150 | $^\circ C$ |
| Operating Junction and Storage Temperature Range | T_J, T_{STG} | -55 to +150 | $^\circ C$ |

Thermal Performance

| Parameter | Symbol | Limit | Unit |
|--|-----------------|-------|--------------|
| Lead Temperature (1/8" from case) | T_L | 5 | S |
| Junction to Ambient Thermal Resistance (PCB mounted) | $R_{\theta JA}$ | 100 | $^\circ C/W$ |

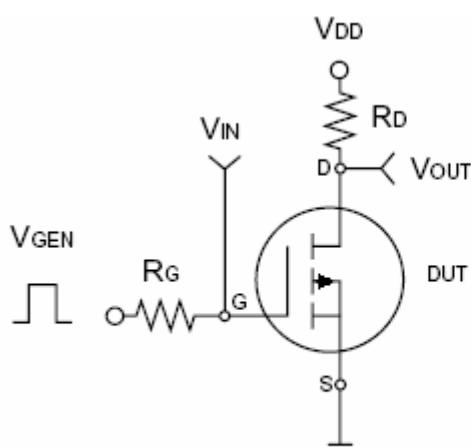
Note: Surface mounted on FR4 board $t \leq 5$ sec.

Electrical Characteristics

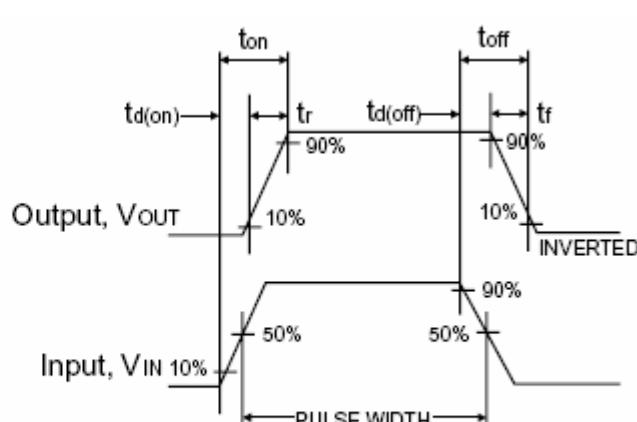
T_a = 25 °C, unless otherwise noted

| Parameter | Conditions | Symbol | Min | Typ | Max | Unit |
|----------------------------------|--|---------------------|-----|-------|-------|------|
| Static | | | | | | |
| Drain-Source Breakdown Voltage | V _{GS} = 0V, I _D = - 250uA | BV _{DSS} | 30 | -- | -- | V |
| Drain-Source On-State Resistance | V _{GS} = 10V, I _D = 3.5A | R _{DS(ON)} | -- | 40 | 50 | mΩ |
| Drain-Source On-State Resistance | V _{GS} = 4.5V, I _D = 2A | R _{DS(ON)} | -- | 55 | 70 | |
| Gate Threshold Voltage | V _{DS} = V _{GS} , I _D = - 250uA | V _{GS(TH)} | 1 | 1.7 | 2.5 | V |
| Zero Gate Voltage Drain Current | V _{DS} = 24V, V _{GS} = 0V | I _{DSS} | -- | -- | 1.0 | uA |
| Gate Body Leakage | V _{GS} = ±20V, V _{DS} = 0V | I _{GSS} | -- | -- | ±100 | nA |
| On-State Drain Current | V _{DS} = 5V, V _{GS} = 10V | I _{D(ON)} | 10 | -- | -- | A |
| Forward Transconductance | V _{DS} = 5V, I _D = 3.5A | g _{fs} | -- | 6 | -- | S |
| Dynamic | | | | | | |
| Total Gate Charge | V _{DS} = 10V, I _D = 3.5A, V _{GS} = 4.5V | Q _g | -- | 6.8 | -- | nC |
| Gate-Source Charge | | Q _{gs} | -- | 3.1 | -- | |
| Gate-Drain Charge | | Q _{gd} | -- | 1.95 | -- | |
| Turn-On Delay Time | V _{DD} = 10V, R _L = 10Ω, I _D = 1A, V _{GEN} = 10V, R _G = 6Ω | t _{d(on)} | -- | 14.2 | -- | nS |
| Turn-On Rise Time | | t _r | -- | 4.8 | -- | |
| Turn-Off Delay Time | | t _{d(off)} | -- | 19.6 | -- | |
| Turn-Off Fall Time | | t _f | -- | 9.3 | -- | |
| Input Capacitance | V _{DS} = 10V, V _{GS} = 0V, f = 1.0MHz | C _{iss} | -- | 600 | -- | pF |
| Output Capacitance | | C _{oss} | -- | 125 | -- | |
| Reverse Transfer Capacitance | | C _{rss} | -- | 95 | -- | |
| Source-Drain Diode | | | | | | |
| Diode Forward Voltage | I _S = - 1.6A, V _{GS} = 0V | V _{SD} | -- | - 0.8 | - 1.2 | V |

Note : pulse test: pulse width <=300uS, duty cycle <=2%



Switching Test Circuit



Switchin Waveforms

Typical Characteristics Curve ($T_a = 25^\circ\text{C}$ unless otherwise noted)

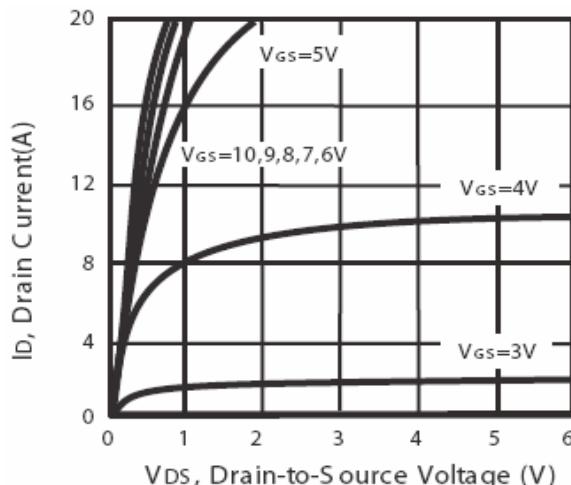


Figure 1. Output Characteristics

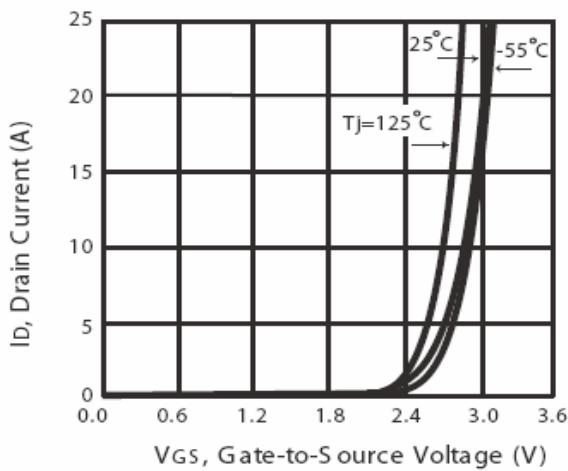


Figure 2. Transfer Characteristics

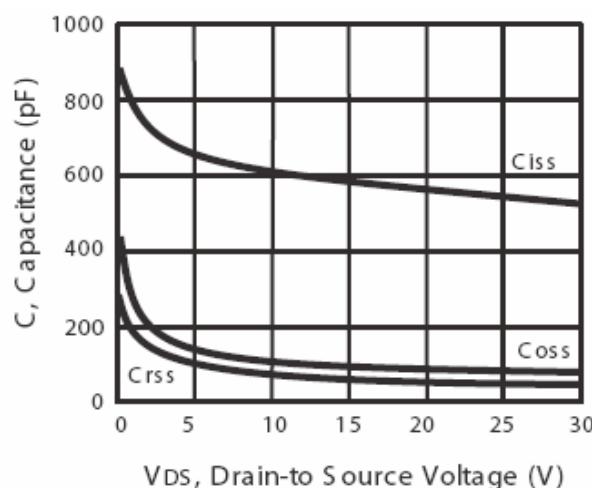


Figure 3. Capacitance

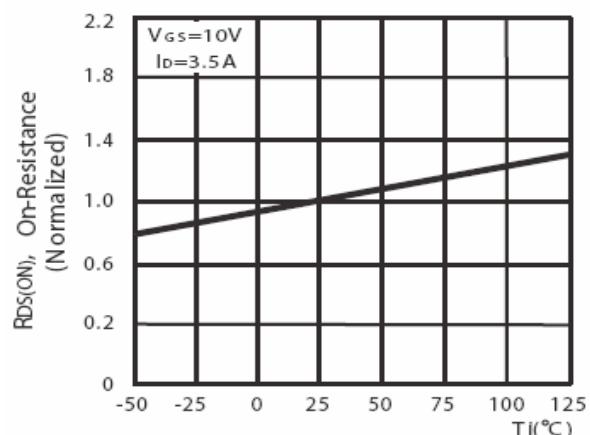


Figure 4. On-Resistance Variation with Temperature

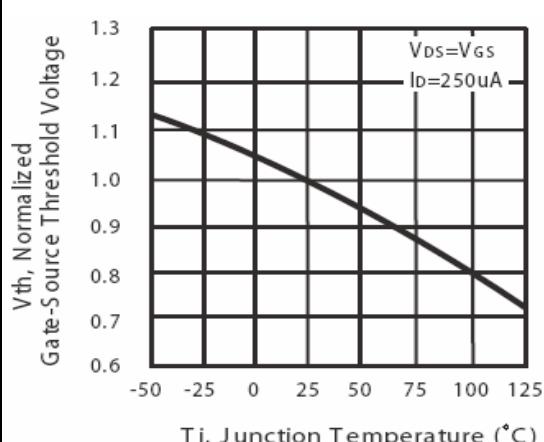


Figure 5. Gate-Source Threshold Voltage with Temperature

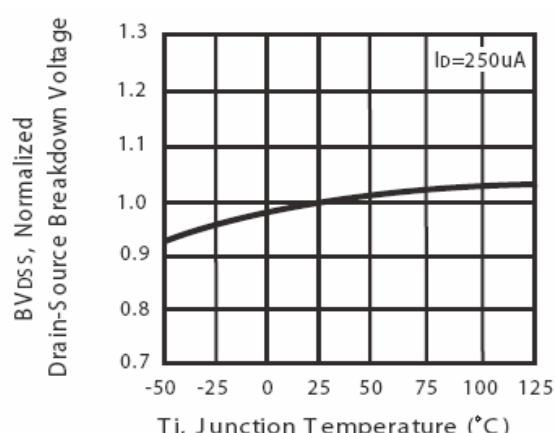


Figure 6. Breakdown Voltage Variation with Temperature

Typical Characteristics Curve ($T_a = 25^\circ\text{C}$ unless otherwise noted)

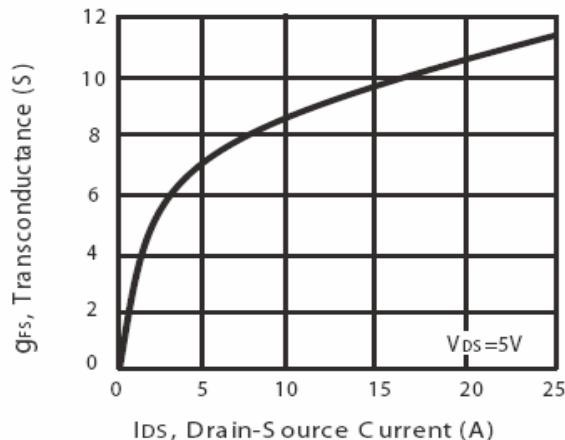


Figure 7. Transconductance Variation with Drain Current

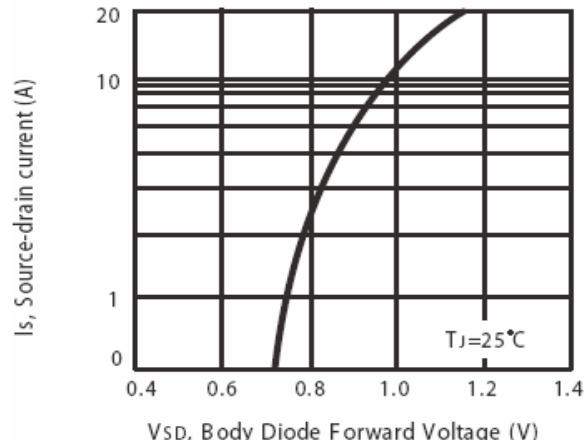


Figure 8. Body Diode Forward Voltage Variation with Source Current

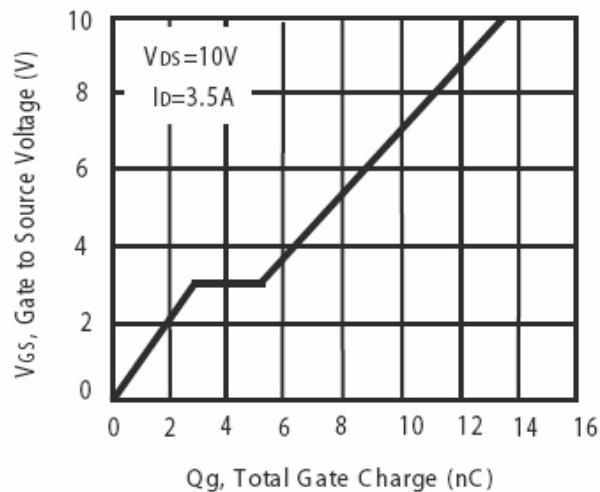


Figure 9. Gate Charge

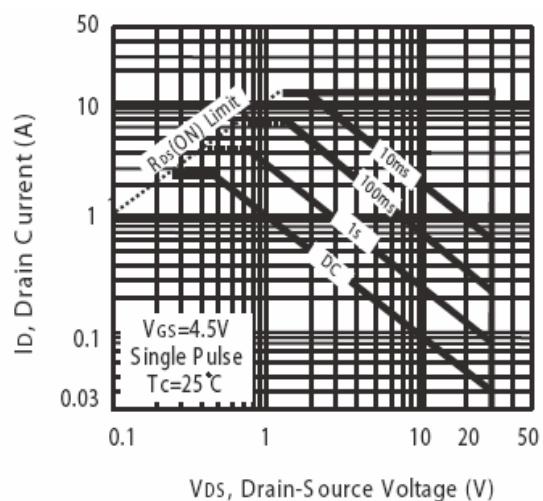
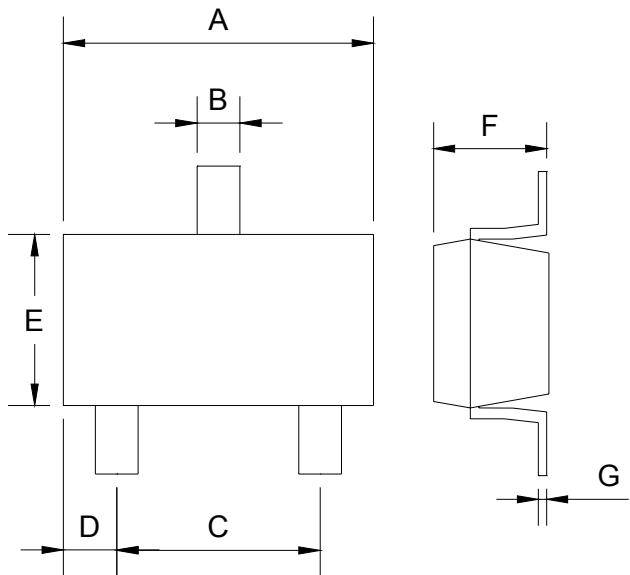


Figure 10. Maximum Safe Operating Area

SOT-23 Mechanical Drawing



| SOT-23 DIMENSION | | | | |
|------------------|-------------|------|--------|-------|
| DIM | MILLIMETERS | | INCHES | |
| | MIN | MAX | MIN | MAX |
| A | 2.88 | 2.91 | 0.113 | 0.115 |
| B | 0.39 | 0.42 | 0.015 | 0.017 |
| C | 1.78 | 2.03 | 0.070 | 0.080 |
| D | 0.51 | 0.61 | 0.020 | 0.024 |
| E | 1.59 | 1.66 | 0.063 | 0.065 |
| F | 1.04 | 1.08 | 0.041 | 0.043 |
| G | 0.07 | 0.09 | 0.003 | 0.004 |